

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Buffer Modules

TSP-BFM Series, 90-600 Watt

CEMC





Features

- Capacitor bank for energy storage, no battery needed!
- Guaranteed Hold-up-time 200 ms / 25 A to 4 s / 1.2 A max.
- ◆ Output 24 to 28 VDC, 600W max.
- Active ready and inhibit signals
- Maintenance free, long lifetime, performance also at low temperature
- 3-year product warranty



The TSP-BFM24 buffer module will hold the output voltage of a 24 VDC power supply after brown outs or voltage dips of ten 50 Hz cycles at full load. During this buffer period no deterioration of the 24 VDC output voltage will occur. For many applications this buffer module is an ideal and cost effective alternative to a battery based backup system. The buffer module consists of a large bank of capacitors. When the power supply is switched on, the buffer capacitors will be charged. This will take approximately 30 seconds and an opto-coupler signal indicates the "READY" condition. When a power fail occurs, the capacitor bank is discharged, maintaining the output of the buffer module at its nominal voltage. This condition is indicated by a "POWER FAIL" signal. The hold up time is typically 200 ms at 25 A and 4 seconds typically at 1.2 A. After 4 seconds the buffer device will switch off the output voltage. The operating modes of the module are also indicated by a LED on the front panel. The major advantage of this buffer solution is, that it is fully maintenance free and its storage capability does not deteriorate over the live time of the product.

Models					
Order Code	Input	Buffer Time	Output Voltage adjust.	Output Current max.*	Output Power max.
TSP-BFM24	24 VDC	200 ms typ. @ 25 A max. 4 s max. @ 1.2 A	24 VDC	25.0 A	600 W

^{*} Maximum current at nominal Vout

Buffer Module	Possible TSP input source	
	TSP 90-124	
	TSP 90-124N	
TSP-BFM24	TSP 180-124	
	TSP 360-124	
	TSP 600-124	

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Output Specifications				
Ouput Voltage adjustable range with potentiometer	22 - 28 VDC			
Ripple and noise (20 MHz bandwidth)	200 mVp-p typ.			
Parallel operation	2 devices possible			

General Specifica	ations		
Operating temperature		-25°C to +70°C max. derating above +40°C: 1.5 %/K	
Storage temperature		-25°C to +85°C max.	
Temperature coefficient	<u> </u>	0.02 %/K	
Humidity (non condens		5 % to 90 % rel. H max.	
<u> </u>	MTBF at +25°C acc. to IEC 61709	>3.3 Mio h	
Buffer voltage		adjustable, >1 V below input voltage, min. 22 VDC	
Charging		0.6 A max. / 30 s max.	
Status signals		Buffer Active , Buffer Ready (optocoupler output) and dual colour LED for status indication	
Inhibit		optocoupler input: 35V max. <5mA	
Alarm outputs		28 VDC / 10 mA	
Degree of protection		IP 20 (IEC/EN 60529)	
Isolation		according to IEC/EN 60950-1, UL 60950-1, UL 508	
Altitude during operation	on	tba.	
Safety standard		IEC/EN 60950-1, UL 60950-, UL 508	
Safety approvals	CSACB test certificateCertification documents	UL 60950, UL 508 IEC 60950-1 (SIQ for EN) www.tracopower.com/overview/tsp	
Electromagnetic compatibility		in correspondence to connected units (no internal switching device)	
Environment	Vibration acc. IEC 60068-2-6;Shock acc. IEC 60068-2-27	3 axis, sine sweep, 10 – 55 Hz, 1 g, 1 oct/min 3 axis, 15 g half sine, 11 ms	
Enclosure material		aluminium (chassis) / stainless steel (cover)	
Mounting	– DIN-rail mounting	for DIN-rails as per EN 50022-35x15/7.5 (snap-on with self-locking spring)	
	– Wall mounting (option)	with wall mounting bracket - see page 4	
Connection		detachable screw terminals (plugs included)	
Installation instructions		www.tracopower.com/overview/tsp	

All specifications valid at nominal input voltage, full load and $+25^{\circ}\text{C}$ after warm-up time unless otherwise stated.

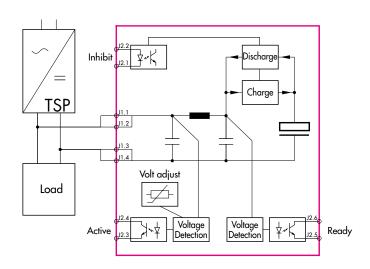
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Buffer Modules TSP-BFM Series 90–600 Watt

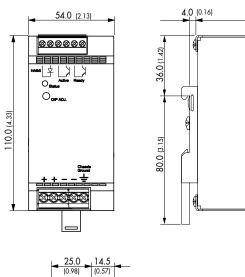
Function

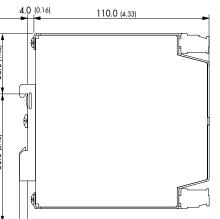
Function Diagram:

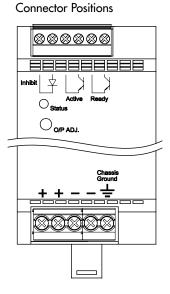


Outline Dimensions

TSP-BFM24





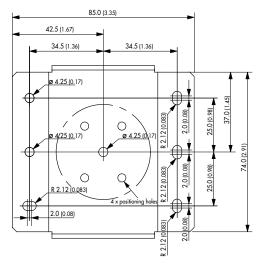


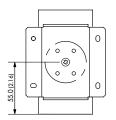
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TSP-WMK Wall Mounting Bracket				
Ordercode of Kit	For Models	Content of Kit		
TSP-WMK03	TSP-BFM24	1 bracket		

TSP-WMK03







Material: 2 mm Mild Steel Tolerance: ±0.1 mm (± 0.004)